Form 1449 (Modified) Atty. Docket No. IPVBP003 Application No.: 10/826,531 Applicant CHEUNG et al. Filing Date April 15, 2004 Group 2614 Page 1 of 1

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Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.